TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSVI-H)

TPCA8053-H

Switching Regulator Applications Motor Drive Applications DC-DC Converter Applications

- Small footprint due to a small and thin package
- · High-speed switching
- Small gate charge: Q_{SW} = 6.9 nC (typ.)
- Low drain-source ON-resistance: $R_{DS (ON)} = 13.9 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: |Yfs| = 46 S (typ.)
- Low leakage current: $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 60 \text{ V)}$
- Enhancement mode: V_{th} = 1.3 to 2.3 V (V_{DS} = 10 V, I_D = 0.2 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characte	eristic	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Drain-gate voltage (R	GS = 20 kΩ)	V_{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ID	15	Α	
Drain current	Pulsed (Note 1)	I_{DP}	45		
Drain power dissipati	on (Tc = 25°C)	P_{D}	30	W	
Drain power dissipati	on (t = 10 s) (Note 2a)	P_{D}	2.8	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.6	W	
Single-pulse avalance	ne energy (Note 3)	E _{AS}	16	mJ	
Avalanche current		I _{AR}	15	Α	
Repetitive avalanche (To	energy c = 25°C) (Note 4)	E _{AR}	1.53	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55 to 150	°C	

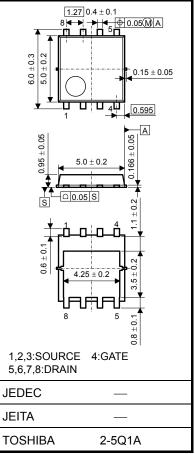
Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e.

operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

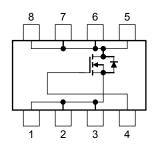
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.069 g (typ.)

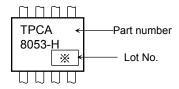
Circuit Configuration



Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc = 25°C)	R _{th (ch-c)}	4.17	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	78.1	°C/W

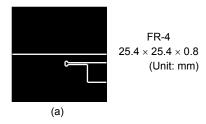
Marking (Note 5)

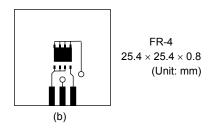


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)





Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 100 μ H, R_G = 25 Ω , I_{AR} = 15 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)



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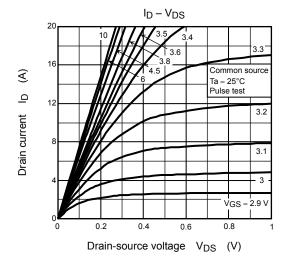
Electrical Characteristics (Ta = 25°C)

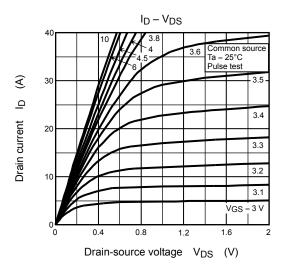
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cutoff curre	nt	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	10	μА
Drain source broa	rain-source breakdown voltage		$I_D = 10$ mA, $V_{GS} = 0$ V	60	_	_	V
Dialii-source brea	akdowii vollage	V (BR) DSX	$I_D = 10$ mA, $V_{GS} = -20$ V	43	— — 10 60 — — 43 — — 1.3 — 2.3 — 15.6 24.0 — 13.9 22.3 23 46 — — 60 90 — 200 — — 2.3 3.5 — 2.4 — — 9.1 — — 7.0 — — 33 —	v	
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_D = 0.2 \text{ mA}$	1.3	_	2.3	V
Drain-source ON-	resistance	Pro (ON)	$V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$		15.6	24.0	mΩ
Dialii-source Oil	-iesistarice	R _{DS} (ON)	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$	60 — 43 — 1.3 — 2.3 — 15.6 24.0 — 13.9 22.3 23 46 — 1620 2110 — 60 90 — 200 — 2.3 3.5 — 2.4 — 9.1 — 7.0 — 33	11152		
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}$	23	46	_	S
Input capacitance		C _{iss}			1620	2110	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	90	
Output capacitance		Coss		_	200	_	
Gate resistance		rg	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 5 \text{ MHz}$	_ 2.3 3.5		3.5	Ω
Suitabing time	Rise time	t _r	V _{GS} 10 V D = 7.5 A C C V C C C C C C C	_	2.4	_	ns
	Turn-on time	t _{on}		_	9.1	_	
Switching time	Fall time	t _f		_	7.0	_	
	Turn-off time	t _{off}	$V_{DD} \approx 30 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	33	_	
Total gate charge	Fotal gate charge		$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	_	25	_	
(gate-source plus	gate-drain)	Qg	$V_{DD} \approx 48 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 15 \text{ A}$	_	_ 13 _		
Gate-source charge 1		Q _{gs1}		_	5.5	_	nC
Gate-drain ("Miller") charge		Q _{gd}	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		4.4	_	
Gate switch charge		Q _{SW}		_	6.9	_	

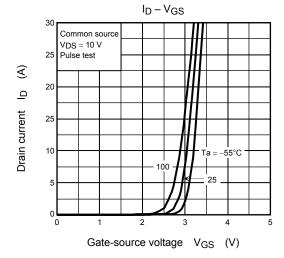
Source-Drain Ratings and Characteristics (Ta = 25°C)

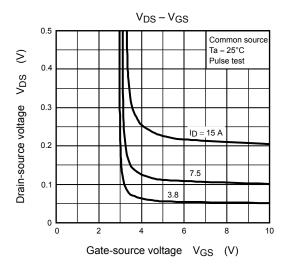
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	45	Α
Forward voltage (diode)			V_{DSF}	$I_{DR} = 15 \text{ A}, V_{GS} = 0 \text{ V}$			-1.2	V

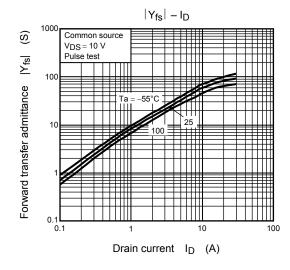
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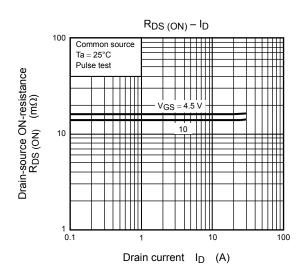


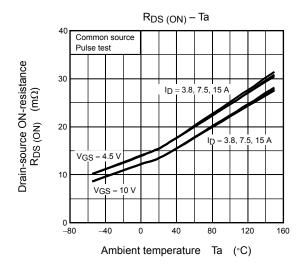


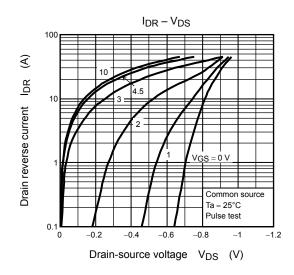


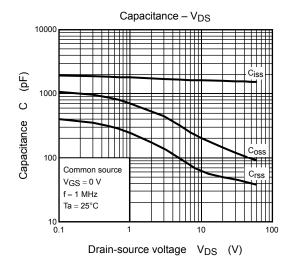


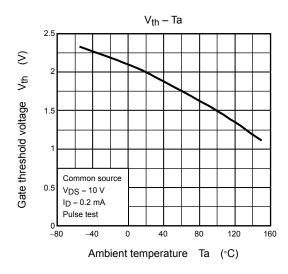


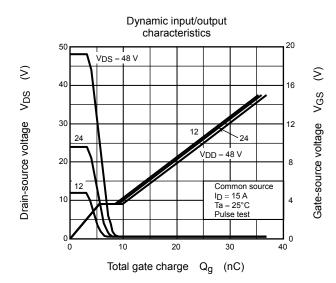




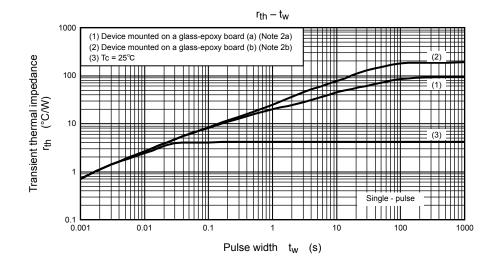


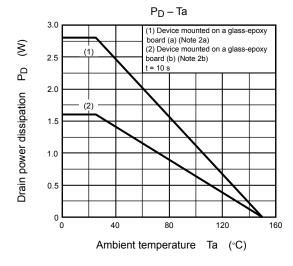


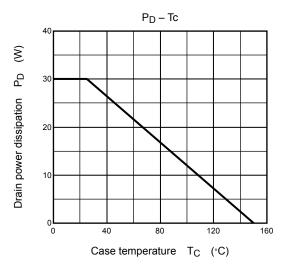


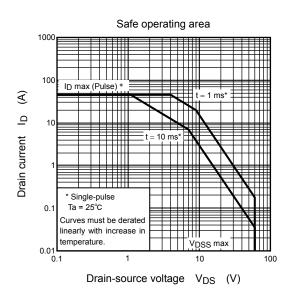


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